









PRODUCT DATASHEET



- ► EMC SMD
- ➤ 3030 0.65t Series
- ► W/R/G/B 4-in-1

N0M62S16











APPLICATIONS:

- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- **Commercial Lighting**
- **Architectural Lighting**
- Home Appliance
- Led Torch
- Mini Projector

FEATURES:

- Package: TOP View EMC WRGB SMT Package
- Forward Current: 150/150/150/150mA*
- Forward Voltage (typ.): 3.3/2.4/3.4/3.3V
- Luminous Flux (typ.): 56/23/35/10lm@150mA
- Colour: Warm White/Red/Green/Blue
- CCT/Wavelength: 2700K/620/525/460nm
- Viewing angle: 120°
- **Materials:**
 - Die: InGaN/AlGaInP/InGaN/InGaN
 - Resin: Silicon
 - L/T Finish: Ag plated
- Operating Temperature: -40~+70°C
- Storage Temperature: -40~+70°C
- **Grouping parameters:**
 - Forward Voltage
 - Luminous Flux
 - CCT/Dominant Wavelength
- Soldering methods: Reflow
- Preconditioning: MSL 3 according to J-STD020
- Packing: 8mm tape with max.5000/reel, ø178mm (7")

^{*} in order of White/Red/Green/Blue



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	150	mA
Pulse Forward Current (width≤100μS; duty≤1/10)	I _{FP}	225	mA
Power Dissipation	P _D	540/420/555/540*	mW
Reverse Voltage	VR	7	V
Reverse Current @7V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Operating Temperature	T_OPR	-40~+70	°C
Storage Temperature	T _{STG}	-40~+70	°C
Soldering Temperature	T _{SOL}	230 or 260 for 10S	°C

^{*} in order of White/Red/Green/Blue

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Cumbal	Values				Test
Parameter Symbol -		Min. Typ.		Max.	Unit	Condition
Forward Voltage	VF	3.0/2.2/3.0/3.0*	3.3/2.4/3.4/3.3	3.6/2.8/3.7/3.6	V	I _F =150mA
Luminous Flux	Ф۷	50/20/30/9	56/23/35/10	60/26/38/12	lm	I _F =150mA
White Colour Temperature	ССТ		2700		K	I _F =150mA
R/G/B Dominant Wavelength	λ_{D}	615/520/455		625/530/465	nm	I _F =150mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =150mA

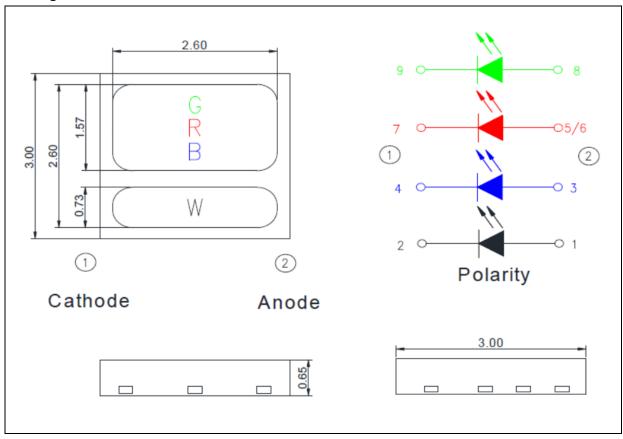
^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V

 $^{{\}it 2.} \hspace{0.5cm} \hbox{* in order of White/Red/Green/Blue} \\$



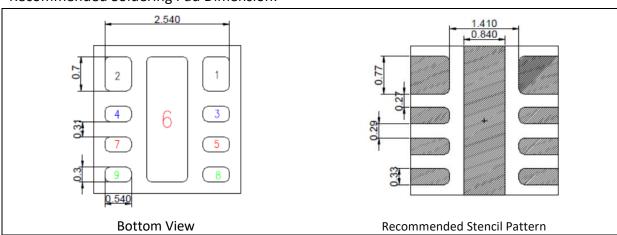
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 150mA):

Co	ode	Min.	Max.	Unit
White	WV1	3.0	3.6	V
Red	RV1	2.2	2.8	V
Green	GV1	3.0	3.7	V
Blue	BV1	3.0	3.6	V

Luminous Flux Classifications (I_F = 150mA):

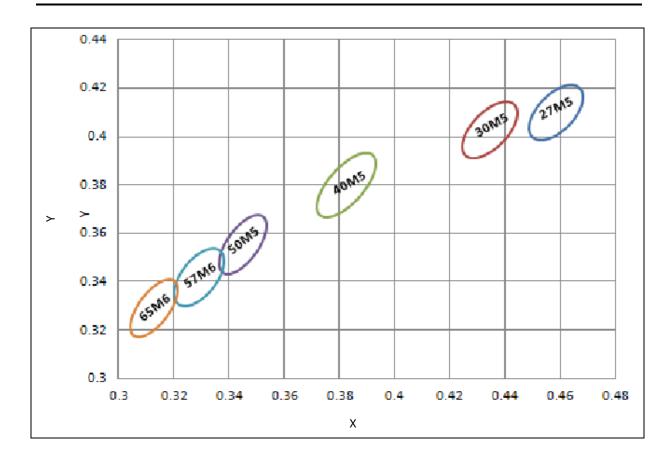
Co	ode	Min.	Max.	Unit
White	WF1	50	60	lm
Red	RF1	20	26	lm
Green	GF1	30	38	lm
Blue	BF1	9	12	lm

Dominant Wavelength Classifications (IF = 150mA):

Code		Min.	Max.	Unit
Red	RC1	615	620	222
Reu	RC2	620	625	nm
Croon	GC1	520	525	nm
Green	GC2	525	530	
Dlug	BC1	455	460	
Blue	BC2	460	465	nm



CIE CHROMATICITY DIAGRAM:



Chromaticity Coordinates Classifications (IF = 150mA):

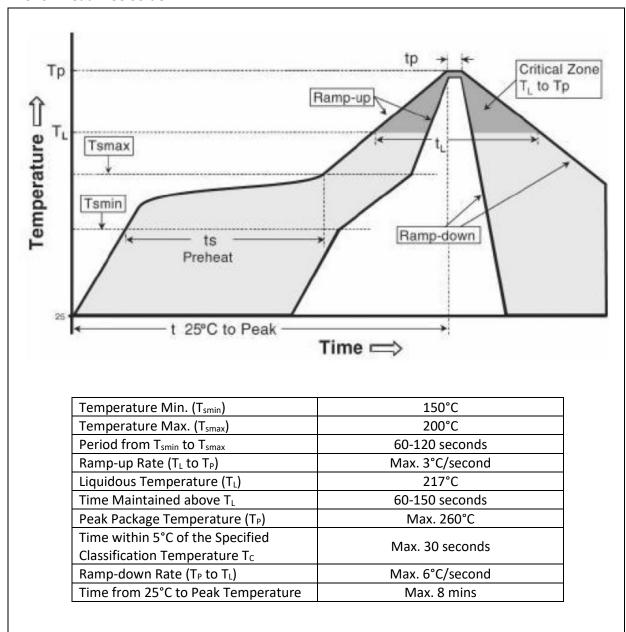
. / 9/	Code	Centre		Radius		Angle
To you	Code	Х	Υ	а	b	Ф
	27M5	0.4582	0.4099	0.013500	0.007000	53.42

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RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



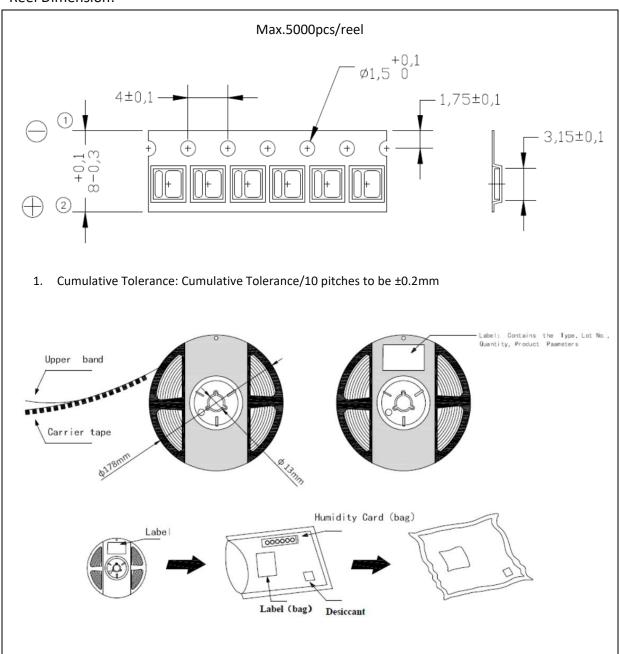
Note:

- 1. Die slug is to be soldered.
- 2. Maximum reflow soldering: 2 times. Between two soldering it should not be longer than 24 hours
- 3. Before, during, and after soldering, should not apply stress on the components and PCB
- 4. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

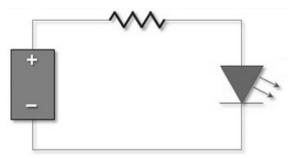
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	04/09/2022	Datasheet set-up.